

# Ultra High-speed High-precision Laser Displacement Sensor

HL-C2 SERIES



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This product is classified as a Class 1 / Class 2 / Class 3R Laser Product in IEC / JIS standards and a Class 1\* /Class II / Class 2\* / Class Illa / Class 3R\* Laser Product in FDA regulations. Never look at or touch the direct laser beam and its reflection.

This product complies with 21 CFR 1040.10 and 1040.11 Laser Notice No. 50, dated June 24, 2007, issued by CDRH (Center for Devices and Radiological Health) under the FDA (Food and Drug Administration).

### The No.1\* industry leader in application compatibility with 34 different sensor head variations \* As of May 2017, in-company survey

Combining our accumulated and the latest technologies to

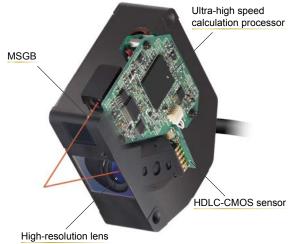
\* As of May 2017, in-company survey

# accomplished\* functionality

### Our proprietary measurement CMOS, the "HDLC-CMOS Sensor"

The HDLC-CMOS sensors have been developed specially for the HL-C2 series. High density light-receiving cells and a processing speed close to the maximum limit result in high resolutions and high speeds which exceed all expectations for laser displacement sensors.

HDLC: High Density Linear Cell



# ■ Comparison of cell structures (image) cell width Previous HL-C2 series

### "MSGB" laser with sharp and fine projection

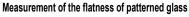
We have created the ideal laser using our proprietary optical technologies and aperture construction. Furthermore, emission adjustment algorithms have been redesigned to maintain ideal emission conditions.

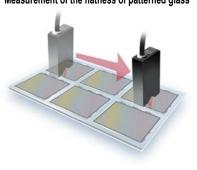
MSGB: Micro Spot Gaussian Beam

# ■ Comparison of beam diameter HL-C2 series Previous-30 µm 1.181 mil Image

HL-C201A ø20 μm ø0.787 mil approx. HL-C203B ø30 µm ø1.181 mil approx. HL-C205B ø70 μm ø2.756 mil approx. HL-C208B ø100 µm ø3.937 mil approx. HL-C211B ø80 µm ø3.150 mil approx. HL-C235BE ø250 µm ø9.843 mil approx. /HL-C235CE-W ø400 µm ø15.748 mil approx.

### **APPLICATIONS**









Measurement of the shape of a camshaft

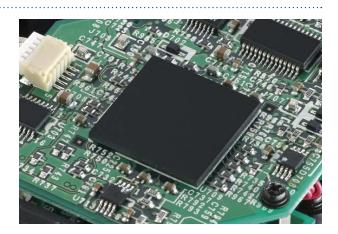






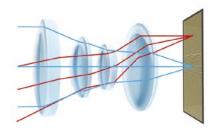
### Ultra high-speed calculation processor

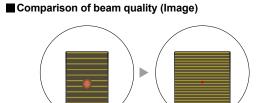
Using our specialized proprietary IC and custom algorithms for high-speed processing, information is digitally transmitted between the sensor head and controller. Both high-speed transmission and stability are realized for measurement values.



### "High-resolution lens" for realizing stable optical path lengths

We designed a new high-resolution lens to reduce lens aberration as much as possible. Light entering from any angle can be gathered at a minimum point to realize even higher precision.





Previous

**HL-C2** series

Image

### A diverse array of sensor heads for your application needs

### For automobile and vehicle parts measurement

Automobile and vehicle parts production facilities





Linear beam spot type



The measurement mode setting is compatible with a variety of workpieces

Select the optimal digital processing for the object to be measured.

Translucent (plastic)

Metal surfaces with coarse finishing (hairlines)

### Penetration · Translucent objects

Translucent plastics

### Diffuse [Standard]

- · Non-mirrored surfaces or opaque objects
- Metal, plastic, rubber, ceramic, etc.

## Metal 1

- · Metal with hairlines
- Extruded materials. rolled materials, etc

# Metal 2

- · Metal with strong hairlines
- Objects with fine scratches, cutting marks, or ground surfaces

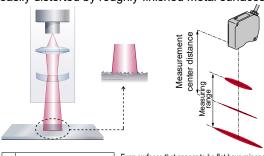
### Long-range sensor heads

Our lineup includes long-range sensor heads with measurement center distances of 110 mm 4.331 in and 350 mm 13.780 in. By keeping distance from the workpiece, the risk of sensor damage from contact with the workpiece can be reduced.

- Measurement center distance: 110 ±15 mm HL-C211B(-MK) 4.331 ±0.591 in HL-C211C(-MK)
- Measurement center distance: 350 ±50 mm HL-C235BE(-MK) 13.780 ±1.969 in HL-C235CE(-MK)
- Measurement center distance: 350 ±200 mm HL-C235CE-W(MK) 13.780 ±7.874 in

### Linear beam spot type sensor heads

We offer linear beam spot type sensor heads with various measurement center distances that are not easily distorted by roughly-finished metal surfaces.





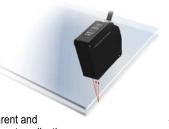
Even surfaces that appear to be flat have minor surface variations when viewed under magnification. These variations can cause errors in measurement. Linear beam spot type sensors average out the influence of these variations, allowing for stable measurement of roughly-finished workpieces.

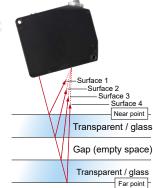
### For measurement of glass height and thickness

Measurement mode setting

Emission adjustment area specification

### FPD and solar panel production facilities





### The measurement mode setting is compatible with a variety of workpieces

A specular reflection installation is required for measurement of transparent and mirrored-surface objects. Select the digital processing for the measurement application.

# Glass

Glass Pattern

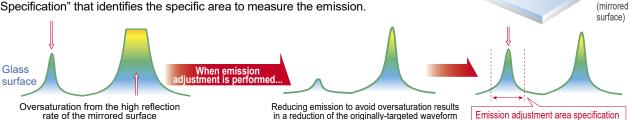
# Specular [Standard]

- · Mirrored surfaces or transparent objects · Gaps between glass, · Glass front and back surfaces
  - glass thickness

### · Patterned glass

### Emission adjustment area specification allows for measurement of glass surfaces

Glass surfaces can be accurately measured by combining the "Emission Adjustment" that determines the optimal emission amounts with the "Emission Adjustment Area Specification" that identifies the specific area to measure the emission.



Emission adjustment area specification selects the area for more accurate measurement

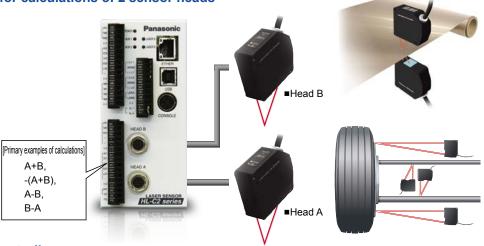
Glass

pattern

### Controllers that provide both convenience and improved product quality

### On-board processing for calculations of 2 sensor heads

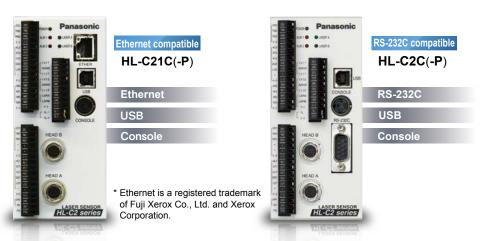
The controller is equipped to perform basic calculations and output results for applications such as thickness measurement for sandwiched layers and 2-point gap measurement. This can reduce computational burdens for host controllers (such as PLCs).



### Connectivity to host controllers

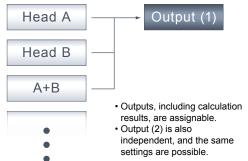
Our controller lineup offers Ethernet, USB, and RS-232C connections. The controllers can connect to devices such as PCs and PLCs.

\* An API (Application Programming Interface) and sample programs can be downloaded for free from our web site for operating the controller using a PC connected by USB.



### A full range of output ports allows output in line with your needs

Both Output (1) and Output (2) mounted on the controller provide independent analog outputs, various output signals (judgment, alarm, etc.), and various input signals (laser emission stop, zero set, etc.).



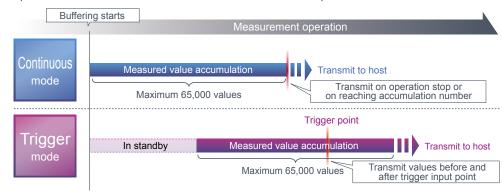
us	o: Available	Output (1)	Output (2)
<u>.=</u>	Analog voltage	0	0
ircu	Analog current	0	0
nt c	Hi / Go / Low judgment	0	0
Output circuit	Alarm	0	0
O	Strobe	0	0
cuit	Zero set	0	0
Input circuit	Timing	0	0
ldul	Reset	0	0

\* Other functions such as laser control (emission stop) input and memory change are also on-board.

### Buffering function allows for temporary accumulation of measured values

The buffering function allows measurement values acquired from high-speed sampling (10 µs) to temporarily accumulate in the controller, which are then transmitted to the host. A maximum of 65,000 values can be accumulated.

The accumulation of shape data can contribute to traceability and other activities. Furthermore, in trigger mode, by sending a trigger input when there is an error, measured values before and after the error can be acquired to help determine the cause of the error.

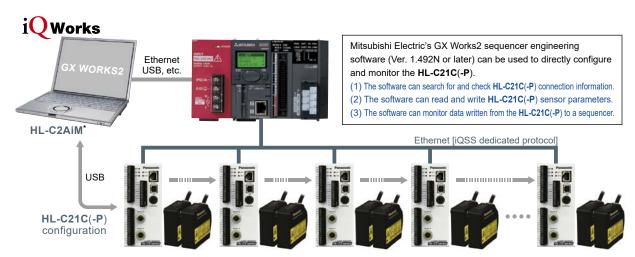


### Providing increased connectivity and compatibility with host devices

# Measurement status can be acquired with a programmable controller easily and without any need for programming

The **HL-C21C(-P)** supports the MEWTOCOL protocol (used by our programmable controllers), the MC protocol (used by Mitsubishi Electric's MELSEC-Q and MELSEC-L series) as well as the iQSS dedicated protocol (used by Mitsubishi Electric's MELSEC-L series), allowing measured values and other information to be written automatically to the data registers of programmable controllers without any need for programming.

\* iQSS is an abbreviation for Mitsubishi Electric's iQ Sensor Solution. \* iQSS and iQ Works are registered trademarks of Mitsubishi Electric Corporation.

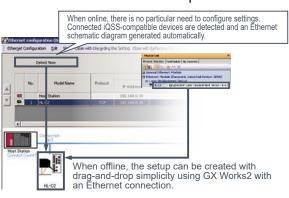


\* HL-C2AiM: HL-C2 dedicated intelligent monitor (available for download free of charge on our website)

### Easy setup

**HL-C21C(-P)** connection settings can be set up using automatic detection of connected devices and drag-and-drop simplicity.

### Reduces development man-hours.



\* Use Mitsubishi Electric's GX Works2 sequencer engineering software (Ver. 1.492N or later).

### Sensor monitoring

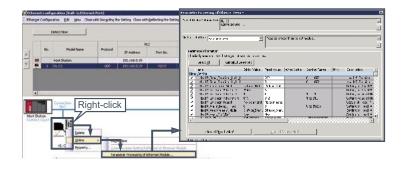
The **HL-C21C(-P)**'s measurement status can be easily monitored.



# Reading and writing of sensor parameters

**HL-C21C(-P)** sensor parameters can be read and written easily.

- \* The HL-C21C(-P)'s Ethernet communications settings must be configured using Configurator WD (Ver. 1.62 or later of our Ethernet communications configuration tool).
- (This software is available for download free of charge from our website.)
- \* The MC protocol is supported for the MELSEC-Q series, and sensors can be monitored.



### Interfaces for convenient setup and setting changes

By combining the GT12 programmable display with our software tools accessed from a PC (HL-C2AiM Intelligent Monitor), received light intensity waveforms and other information can be displayed in addition to the display of measured-value data.

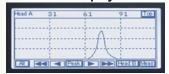
### **GT12 Programmable Display**

### Simple touch panel operation and easy-to-read display



By installing screen application (provided free of charge) onto the GT12 programmable display, it can be used as a dedicated console for viewing waveforms and setting operation conditions. (A proprietary connection cable is required.)

 Received light intensity in waveform display



Condition setting function



Measurement value data display function







### **Intelligent Monitor HL-C2AiM**

Waveform monitoring and function setting by computer is easy to do

\* This software is available for download free of charge from our website.

OS (Note 1)	Microsoft® Windows® 7 Professional 32-bit / 64-bit Microsoft® Windows® 8 Pro 32-bit / 64-bit Microsoft® Windows® 10 Pro 32-bit / 64-bit (Japanese / English / Korean / Chinese)
CPU	1 GHz or above (Note 2)
Memory	2 GB or more (Note 2)
Hard disk	50 MB or more of usable space
Display screen	SXGA (1,280 × 1,024 full color) or above
Serial port	RS-232C compliant, transmission speed 115.2 kbps
USB port	USB 2.0 full speed (USB 1.1 compatible)

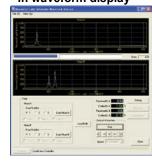
Notes: 1) Windows 7 / 8 / 10 are trademarks or registered trademarks of Microsoft Corporation in the United State and other countries.

2) Depends on the OS operation environment.

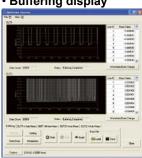
### Measurement value display



 Light receiving intensity in waveform display



Buffering display



<sup>\*</sup> Microsoft and Windows are registered trademarks or trademarks of Microsoft Corporation in the United States and other countries.

### **ORDER GUIDE**

### **Sensor heads**

Type	Appearance	Measurement center distance and	Resolution	Beam size		, ,
1,750	Appearance	measuring range	(Note)	Bedin Size	IEC/JIS conformed type	FDA conformed typ
Small beam spot type		10 ±1 mm	0.01 µm 0.0004 mil	ø20 μm ø0.787 mil approx.	HL-C201A * (HL-C201AE *)	<b>HL-C201F</b> (HL-C201FE)
Linear beam spot type	Maia Senson IN-CO service	0.394 ±0.039 in	(0.25 µm 0.010 mil)	20 × 700 μm 0.787 × 27.559 mil approx.	HL-C201A * (HL-C201AE *) HL-C201A-MK * (HL-C201AE-MK *) HL-C201A-SP2 (HL-C201AE-SP2) HL-C201A-SP2M (HL-C201AE-SP2M) HL-C201AE-SP3M) HL-C201AE-SP3M (HL-C201AE-SP3M) HL-C203B * (HL-C203BE *) HL-C203B-MK * (HL-C203BE-MK *) HL-C203BE-MK * (HL-C203BE-MK *) HL-C203BE-MK * (HL-C203BE-MK *) HL-C203BE-MK * (HL-C203BE-MK *) HL-C203BE-MK * (HL-C203BE-MK *) HL-C210BE-ME-C200BE-C20BE-C200BE	HL-C201F-MK (HL-C201FE-MK)
Small beam spot type	Å	8 ±0.8 mm	0.01 µm 0.0004 mil	ø20 μm ø0.787 mil approx.	<b>HL-C201A-SP2</b> (HL-C201AE-SP2)	
Linear beam spot type		0.315 ±0.031 in	(0.25 µm 0.010 mil)	20 × 700 μm 0.787 × 27.559 mil approx.	HL-C201A-SP2M (HL-C201AE-SP2M)	
Small beam spot type	h	15 ±1 mm	0.01 µm 0.0004 mil	ø30 µm ø1.181 mil approx.	<b>HL-C201A-SP3</b> (HL-C201AE-SP3)	
Linear beam spot type		0.591 ±0.039 in	(0.25 µm 0.010 mil)	30 × 1,400 μm 1.181 × 55.118 mil approx.	HL-C201A-SP3M (HL-C201AE-SP3M)	
Small beam spot type		At diffuse reflection mode	0.025 µm 0.001 mil	ø30 μm ø1.181 mil approx.	HL-C203B * (HL-C203BE *)	<b>HL-C203F</b> (HL-C203FE)
Linear beam spot type		30 ±5 mm 1.181 ±0.197 in	(0.25 µm 0.010 mil)	30 × 1,200 μm 1.181 × 47.244 mil approx.	HL-C203B-MK * (HL-C203BE-MK *)	HL-C203F-MK (HL-C203FE-MK)
Small beam spot type				ø70 μm ø2.756 mil approx.	HL-C20 (HL-C2	
Linear beam spot type		At diffuse reflection mode	0.05 μm 0.002 mil	70 × 1,000 μm 2.756 × 39.370 mil approx.		<b>05B-MK</b> 05BE-MK)
Small beam spot type		50 ±5 mm 1.969 ±0.197 in	(0.25 µm 0.010 mil)	ø70 μm ø2.756 mil approx.	<b>HL-C2</b> (HL-C2	
Linear beam spot type				70 × 1,000 μm 2.756 × 39.370 mil approx.		<b>05C-MK</b> 05CE-MK)
Small beam spot type				ø100 μm ø3.937 mil approx.	<b>HL-C2</b> (HL-C2	
Linear beam spot type	- Annaharan - Anna	At diffuse reflection mode	0.15 μm 0.006 mil	100 × 1,200 μm 3.937 × 47.244 mil approx.		08B-MK 08BE-MK)
Small beam spot type		85 ±20 mm 3.346 ±0.787 in	(0.25 µm 0.010 mil)	ø100 µm ø3.937 mil approx.	<b>HL-C2</b> (HL-C2	
Linear beam spot type				100 × 1,200 μm 3.937 × 47.244 mil approx.		<b>08C-MK</b> 08CE-MK)
Small beam				ø80 µm		<b>HL-C211F</b> (HL-C211FE)
spot type		At diffuse reflection mode	0.1 µm 0.004 mil	ø3.150 mil approx.		<b>HL-C211F5</b> (HL-C211F5E)
Linear beam		110 ±15 mm 4.331 ±0.591 in	(0.25 μm 0.010 mil)	80 × 1,700 μm		HL-C211F-MK (HL-C211FE-MK)
spot type				3.150 × 66.929 mil approx.		<b>HL-C211F5-MK</b> (HL-C211F5E-MK)
Small beam				ø250 µm	HL-C235BE *	
spot type		At diffuse reflection mode	0.5 0.000!	ø9.843 mil approx.	HL-C235CE *	
Linear beam		350 ±50 mm 13.780 ±1.969 in	0.5 μm 0.020 mil	250 × 3,500 μm	HL-C235BE-MK *	
spot type				9.843 × 137.795 mil approx.	HL-C235CE-MK *	
Small beam spot type		At diffuse reflection mode	2 um 0.070 : "	ø400 μm ø15.748 mil approx.	HL-C23	5CE-W
Linear beam	4-	350 ±200 mm 13.780 ±7.874 in	2 μm 0.079 mil	400 × 6,500 μm 15.748 × 255.905 mil approx.	HL-C23	5CE-WMK

Note: Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." However, export control does not apply to the models shown in parentheses on the condition that they are used in combination with a controller (e.g. **HL-C2CE**) to which the export control defined by "Foreign Exchange and Foreign Trade Act" does not apply. In such cases, the minimum resolution is 0.25 µm 0.010 mil. Please contact us for further details.

\* The product has acquired Korean S Mark certification.

### **ORDER GUIDE**

### **Controllers**

Тур	oe .	Appearance	Model No. (Note)
RS-232C-	NPN output	Parameter Services	<b>HL-C2C</b> * (HL-C2CE *)
compatible	PNP output		HL-C2C-P * (HL-C2CE-P *)
Ethernet-	NPN output		HL-C21C (HL-C21CE)
compatible	PNP output	Colores	<b>HL-C21C-P</b> (HL-C21CE-P)

Note: These products have been restricted for export in accordance with the "Foreign Exchange and Foreign Trade Act". However, by combining the parts listed in parentheses with sensor heads which are not restricted for export under the "Foreign Exchange and Foreign Trade Act", products for which the act does not restrict export can be provided. Please contact us for further details.

### **OPTIONS**

Programmable display
It is possible to use the programmable display as an exclusive console which enables waveform display and condition setting by installing it in the screen data (free of charge) for HL-C2.

Produc	ct name	Appearance	Part No.	LCD	Screen size	Power source	Communication port	Front panel color	SD memory card slot
	OT40M	Citto	Recommended AIG12MQ02D	TFT monochrome				Pure black	
GT12	GT12M		AIG12MQ03D	LCD (white backlight) (Note 4)	- 4.6 inch	24 V DC	RS-232C	Hairline silver	
G112	07400	Gra	AIG12GQ02D	TFT monochrome				Pure black	
	GT12G	-	AIG12GQ03D	LCD (green backlight) (Note 4)				Hairline silver	

- Notes: 1) The screen data differs depending on the language. Please download as necessary.

  2) To install the screen data in the display, prepare a PC and a USB cable (A ⇔ mini-B connector type) separately.
  - 3) The provided console screen application has no function to write the data into or download the data from an SD memory card. 4) The backlight color becomes fixed upon the installation of provided screen application.
  - 5) For details of programmable display **GT12**, refer to our website.

### **Others**

Designation	Appearance	Model No.	Descrip	otion						
ND filter		HL-C2F01	When the amount of reflected light is large at the time that a specular reflective senso installed, reducing the amount of laser light to an appropriate level enables a high precision measurement. (Light detection rate: 98 %) (Cannot be used with <b>HL-C201</b> □.)							
		HL-C2CCJ2	Length: 2 m 6.562 ft, Weight: 0.2 kg approx.							
		HL-C2CCJ5	Length: 5 m 16.404 ft, Weight: 0.4 kg approx.	Cabtyre cable with connector on both ends						
Sensor head extension cable		HL-C2CCJ10	Length: 10 m 32.808 ft, Weight: 0.7 kg approx.	Cable outer diameter: ø6.6 mm ø0.260 in Connector outer diameter: ø14.7 mm						
		HL-C2CCJ20	Length: 20 m 65.617 ft, Weight: 1.4 kg approx.	ø0.579 in max.						
			Length: 30 m 98.425 ft, Weight: 2.0 kg approx.							
GT series connector cable for HL-C2	N-0251-03	HL-C2GT-C3	Length: 3 m 9.843 ft	Cable to connect the programmable display GT12 and HL-C2 series controller						

<sup>\*</sup> The product has acquired Korean S Mark certification.

### **Sensor heads**

	Туре				Sm	all bear	n spot	type						
	□		HL-C201A(E)-SP2	HL-C201A(E)-SP3		. ,	HI -C2	05B(E)	HI -C2	05C(F)	HL-C2	08B(F)	HI -C2	08C(F)
Item\	FDA conformed type	HL-C201F(E)				03F(E)			IIL-OZ	000(L)	IIL-02	00D(L)	IIL-02	000(L)
CE m	narking directive compliance				EMC D	Specular	RoHS Diffuse	Specular Specular	Diffuse	Specular	Diffuse	Specular	Diffuse	Specular
Setu	p mode (Note 2)	S	pecular reflection	n	reflection	reflection	reflection	reflection	reflection	reflection	reflection	reflection	reflection	reflection
Meas	surement center distance	10 mm 0.394 in	8 mm 0.315 in	15 mm 0.591 in	30 mm 1.181 in	26.4 mm 1.039 in	50 mm 1.969 in	46 mm 1.811 in	50 mm 1.969 in	46 mm 1.811 in	85 mm 3.346 in	81.4 mm 3.205 in	85 mm 3.346 in	81.4 mm 3.205 in
Meas	suring range (Note 3)	±1 mm ±0.039 in	±0.8 mm ±0.031 in	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±20 mm ±0.787 in	±6 mm ±0.236 in	±20 mm ±0.787 in	±6 mm ±0.236 in
[Ave	olution rage number of samples] e 4, 5)	/ HL-C: 0.04 µr 0.01 µr •HL-C2 / HL-C:	01A / HL-C201A 201A-SP3 / HL- n 0.002 mil [256 n 0.0004 mil [4, 01AE / HL-C201 201AE-SP3 / HL n 0.010 mil [256	C201F: ], 096] AE-SP2 -C201FE:	0.1 µm 0.004 mil [256] 0.025 µm 0.001 mil [4,096] •HL-C203BE   •HL-C205CE: 0.25 µm 0.002 mil [4,096] •HL-C205BE / HL-C205CE: 0.1				0.6 µ 0.15 • <b>HL-C</b> 0.6 µ	•HL-C208B / HL-C208C: 0.6 µm 0.024 mil [256], 0.15 µm 0.006 mil [4,096] •HL-C208BE / HL-C208CE: 0.6 µm 0.024 mil [256], 0.25 µm 0.010 mil [4,096]				
Linea	arity (Note 6)	(HL-C	±0.02 % F.S. <b>201FE</b> : ±0.025 %	% F.S.)			±0.03	% F.S.			±0.03 % F.S.	±0.1 % F.S.	±0.03 % F.S.	±0.1 % F.S.
Tem	prerature characteristics	0.01 % F.S./°C (HL-C201FE: 0.013 % F.S./°C)	0.02 %	F.S./°C	0.01 % F.S./°C									
Limba			Red	semiconductor	laser (P	eak emi	ssion wa	avelengtl	h: 658 ni	m 0.026	mil)			
Light	source	Max. outp	ut: 0.1 mW	Max. output: 0.3 mW	Max. out	out: 1 mW	Max. out	out: 1 mW	Max. outp	ut: 5 mW	Max. outp	out: 1 mW	Max. outp	out: 5 mW
	IEC / JIS conformed type	C	class 1 (IEC / JIS	3)	Class 2 (	IEC / JIS)	Class 2 (	IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (	IEC / JIS)	Class 3R	(IEC / JIS)
	FDA conformed type	Class 1 [FDA (Note 7) / IEC / JIS]			Class	(FDA), 2 (IEC IS)	(IEC FDA (Note 7) / FDA (Note 7) /			Class 2 FDA (Note 7) / IEC / JIS  Class 3R FDA (Note 7) / IEC / JIS			lote 7) /	
Bean	n size (Note 8)	ø20 μm ø0.78	37 mil approx.	ø30 µm ø1.1	.181 mil approx.						37 mil a	pprox.		
Rece	eiving element	Linear image sensor												
ţ	Laser emission	Green LED (lights up during laser emission)												
Indicator	Measuring range	(lights up when no	ear the measureme	ent center distance,	blinks wh		v LED the meas	uring ranç	ge, and lig	hts out w	hen outsid	de of the r	measurinç	g range.)
ခင	Protection			IF	67 (IEC	) (exclud	ling the	connect	or)					
Environmental resistance	Ambient temperature	0 to	+45 °C +32 to +	113 °F (No dew	conden	sation or	icing all	lowed), \$	Storage:	–20 to -	+70 °C –	4 to +15	8 °F	
<u>a</u>	Ambient humidity			35	to 85 %	RH, Sto	age: 35	to 85 %	RH					
ment	Ambient illuminance		In	candescent light	: 3,000 {	x or less	at the l	ight-rece	eiving fac	e (Note	9)			
ion	Vibration resistance	10 to 55 l	Hz (period: 1 mir	n.) frequency, 1.	5 mm 0.	059 in do	ouble an	nplitude	in X,Y a	nd Z dire	ections f	or two h	ours ead	:h
E	Shock resistance	/s² acceleration	(20 G ap	prox.) ir	ı X,Y an	d Z dire	ctions th	ree time	s each					
Cabl	е	Cabtyre	cable, 0	.5 m 1.6	40 ft lon	g with c	onnecto							
Cabl	e extension	extension up to to	otal 30 n	า 98.425	ft is pos	ssible, w	ith optio	nal cable	е.					
Mate	rial		Enclosur	e: Die-cast alum	inum, C	ase cov	er: Die-c	ast alun	ninum, F	ront cov	er: Glas	s		
Weig	ht	250 g approx. (including cable) 300 g approx. (including cable)												
Acce	ssory		La	ser warning lab	els (for a	pplicabl	e standa	ards and	regulati	ons): 1 s	set			
	4) 44													

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24 V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic [aluminum vapor deposition surface reflection mirror for HL-C201A(E) / HL-C201A(E)-SP2 / HL-C201F(E), clear glass for HL-C201A(E)-SP3], and digital measurement value

- 2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation. (Cannot be used
- 3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Model	No.	HL-C201□	HL-C201□-SP2	HL-C201□-SP3	HL-C	203□	HL-C	205□	HL-C208□		
Setup m	node	Specular reflection	Specular reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	
	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	+0.1 to +0.8 mm +0.004 to +0.031 in	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm	0 to +4.6 mm 0 to +0.181 in	+0.5 to +5.0 mm +0.020 to +0.197 in	+0.5 to +5.0 mm	0 to +20 mm 0 to +0.787 in	0 to +6.0 mm	
Sampling	10 116	+0.004 to +0.039 iii	+0.004 to +0.031 iii +0.7 to +0.8mm	+0.8 to +1.0mm	0 to +0.197 in +3.8 to +5.0mm	+3.6 to +4.6mm	+4.7 to +5.0mm	+0.020 to +0.197 in +4.6 to +5.0mm	+18 to +20mm	0 to +0.236 in Measurement	
	10 µs	+0.031 to +0.039 in	+0.028 to +0.031 in	+0.031 to +0.039 in	+0 150 in to +0 197 in	+0 142 to 0 181 in	+0 185 to +0 197 in	+0 181 to +0 197 in	+0 709 to +0 787 in	not possible	

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mill fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE" (p.20).

  6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary
- depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 (June 24, 2007) of FDA regulations (21 CFR 1040.10 and 1040.11).
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e2 (13.5 % approx.) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- 9) Variance is  $\pm 0.03~\%$  F.S. or less depending on the ambient illuminance.

### Sensor heads

	Туре					Small bear	n spot type	,				
	를 IEC / JIS conformed type	HL-C2	11B(E)	HL-C2	11C(E)	HL-C	235BE	HL-C2	235CE	LIL COSECE W		
Item	FDA conformed type	HL-C2	11F(E)	HL-C2	11F5(E)				_	HL-C235CE-W		
CE r	narking directive compliance				1		RoHS Direct					
Setu	p mode (Note 2)	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection		
Mea	surement center distance	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in		
Mea	suring range (Note 3)	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±200 mm ±7.874 in		
[Ave	olution rage number of samples] e 4, 5)	HL-C21 0.1 μm •HL-C21 HL-C21	1B / HL-C21 1F5: 0.4 µm 0.004 mil [4,0 1BE / HL-C2 1F5E: 0.4 µr 0.010 mil [4	0.016 mil [25 096] 2 <b>11CE</b> / <b>HL-C</b> n 0.016 mil [2	[256], <b>L-C211FE</b> / 2.0 μm 0.079 mil [256], 0.5 μm 0.020 mil [4,096]					8 µm 0.315 mil [256], 2 µm 0.079 mil [4,096]		
Line	arity (Note 6)				±0.03	±0.04 % F.S. (-200 to 0 mm -7.874 to 0 ±0.08 % F.S. (0 to +200 mm 0 to +7.874 (F.S. = ±200 mm ±7.874)						
Tem	prerature characteristics					0.01 %	F.S./°C					
Ligh	t source			Red semio	conductor las	er (Peak emi	ssion wavele	ngth: 658 nm	0.026 mil)			
Ligit	t source	Max. outp	out: 1 mW	Max. outp	out: 5 mW	Max. out	out: 1 mW	Max. outp	out: 5 mW	Max. output: 5 mW		
	IEC / JIS conformed type	Class 2 (I	EC / JIS)	Class 3R	(IEC / JIS)	Class 2 (IEC / JIS) Class 3R (IEC / JIS)			(IEC / JIS)	Class 3R (IEC / JIS)		
	FDA conformed type	Class II (I Class 2 (I	FDA), EC / JIS)	Class IIIa Class 3R	(FDA), (IEC / JIS)					Class 3R FDA (Note 7) / IEC / JIS		
Bear	n size (Note 8)	Q	ø80 μm ø3.15	50 mil approx	ζ.	Q	ø250 μm ø9.8	43 mil approx	<b>C</b> .	ø400 μm ø15.748 mil approx.		
Rec	eiving element					Linear ima	age sensor					
tor	Laser emission				Green LE	ED (lights up	during laser	emission)				
Indicator	Measuring range	(lights up whe	n near the mea	surement cente	er distance, blin		w LED the measuring	range, and light	s out when ou	tside of the measuring range.)		
8	Protection	, ,					ding the conn					
Environmental resistance	Ambient temperature	0	to +45 °C +3	32 to +113 °F	(No dew cor	ndensation or	icing allowed	d), Storage: -	20 to +70 °C	2 –4 to +158 °F		
al res	Ambient humidity				35 to 8	5 % RH, Sto	rage: 35 to 85	5 % RH				
Jenta	Ambient illuminance			Incandes	scent light: 3,	000 lx or less	at the light-r	eceiving face	(Note 9)			
ion	Vibration resistance	10 to 5	55 Hz (period	: 1 min.) freq	uency, 1.5 m	m 0.059 in de	ouble amplitu	de in X,Y and	d Z directions	s for two hours each		
Shock resistance 196 m/s² acceleration (20 G approx.) in X,Y and Z directions three times each												
Cab	e				Cabtyre cal	ole, 0.5 m 1.6	640 ft long wit	h connector				
Cab	e extension			Extensi	on up to total	30 m 98.425	ft is possible	e, with optiona	al cable.			
Mate	erial		En	closure: Die-	-cast aluminu	m, Case cov	er: Die-cast a	luminum, Fro	nt cover: Gla	ass		
Wei	ght	30	0 g approx. (i	including cab	ole)	45	60 g approx. (	including cab	le)	300 g approx. (including cable)		
Acce	essory					Laser warnir	ning label: 1 set					
	4) 14		.1					U 04 \ / D				

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24 V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 μs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic, and digital measurement value.

- 2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation.
- 3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Model	No.	HL-C	211□	HL-C	235□	HL-C235CE-W
Setup n	node	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
	20 µs	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	0 to +50 mm 0 to +1.969 in	0 to +42 mm 0 to +1.654 in	-70 to +200 mm -2.756 to +7.874 in
Sampling	10 µs	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	+36 to +50 mm +1.417 to +1.969 in	+36 to +42 mm +1.417 to +1.654 in	+100 to +200 mm +3.937 to +7.874 in

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mill fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE" (p.20).
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 (June 24, 2007) of FDA regulations (21 CFR 1040.10 and 1040.11). 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 % approx.) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity
- than the sensing point itself, then the results may be affected.

  9) Variance is ±0.03 % F.S. or less (±0.08 % F.S. or less for **HL-C235CE-W**) depending on the ambient illuminance.

### Sensor heads

	Туре				Line	ar bea	m spot	type						
	EC / JIS conformed type	HL-C201A(E)-MK	HL-C201A(E)-SP2M	HL-C201A(E)-SP3M	HL-C203	B(E)-MK	III COM	B(E)-MK	LII CONE	C/E) MK	HI -C208	R/E\_MK	HI -C208	C(F)-MK
		HL-C201F(E)-MK				F(E)-MK			HL-0200	C(E)-IVIN	HL-0200	D(E)-WIK	112-0200	O(L)-MIK
CE m	arking directive compliance						RoHS D		Diffuse	Canadar	Diffus	Cassular	Diffuse	Canadar
Setu	p mode (Note 2)		pecular reflection	1	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Meas	surement center distance	10 mm 0.394 in	8 mm 0.315 in	15 mm 0.591 in	30 mm 1.181 in	26.4 mm 1.039 in	50 mm 1.969 in	46 mm 1.811 in	50 mm 1.969 in	46 mm 1.811 in	85 mm 3.346 in	81.4 mm 3.205 in	85 mm 3.346 in	81.4 mm 3.205 in
Meas	suring range (Note 3)	±1 mm ±0.039 in	±0.8 mm ±0.031 in	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±20 mm ±0.787 in	±6 mm ±0.236 in	±20 mm ±0.787 in	±6 mm ±0.236 in
[Ave	olution age number of samples] a 4, 5)	/ HL-C201, 0.04 μm 0. 0.01 μm 0. •HL-C201A / HL-C201,	-MK / HL-C201/ A-SP3M / HL-C2002 mil [256], 0004 mil [4,096] E-MK / HL-C2004 AE-SP3M / HL-C010 mil [256]	201F-MK:   1AE-SP2M	0.025 µm 0.001 mil [256], 0.05 µm 0.002 mil [256], 0.05 µm 0.002 mil [4,096] HL-C203BE-MK /HL-C205E-MK: /HL-C205E-MK: 0.6 µm 0.00					-C208C- μm 0.00 μm 0.00 C208BE -C208Cl μm 0.024	C-MK: 24 mil [256], 006 mil [4,096] E-MK			
Linea	arity (Note 6)	(HL-201	±0.02 % F.S. <b>FE-MK</b> : ±0.025	% F.S.)			±0.03	% F.S.			±0.03 % F.S.	±0.1 % F.S.	±0.03 % F.S.	±0.1 % F.S.
Tem	orerature characteristics	0.01 % F.S./°C (HL-201FE-MK: 0.013 % F.S./°C)	0.02 %	F.S./°C	0.01 % F.S./°C									
Liabt	0011700		Red	semiconductor	laser (P	eak emi	ssion wa	velengtl	h: 658 nı	m 0.026	mil)			
Light	source	Max. output: 0.1 mW Max. output: 0.3 mW				out: 1 mW	Max. out	out: 1 mW	Max. outp	out: 5 mW	Max. outp	ut: 1 mW	Max. outp	out: 5 mW
	Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mil)  Max. output: 0.1 mW Max. output: 0.3 mW Max. output: 1 mW Max. output: 1 mW Max. output: 5 mW Max. outpu													
	FDA conformed type	Class 1 [FDA (Note 7) /] IEC / JIS							Class 2 [FDA (Note 7) / IEC / JIS]  Class 3R  FDA (Note 7 IEC / JIS			lote 7) /		
Bean	n size (Note 8)	20 × 7 0.787 × 27.55		30 × 1,400 μm 1.181 × 55.118 mil approx.	30 × 1,200 µm 1.181 × 47.244 mil approx. 2.756 × 39.370 mil approx.					100 × 1,200 μm 3.937 × 47.244 mil approx.				
Rece	iving element				Li	near ima	ige sens	or						
to	Laser emission			Green	ı LED (li	ghts up	during la	aser emi	ssion)					
Indicator	Measuring range	(lights up when ne	ear the measureme	ent center distance,	blinks wh		v LED the meas	uring rang	ge, and lig	hts out w	hen outsid	de of the r	neasuring	g range.)
92	Protection			IP	67 (IEC	) (exclud	ling the	connecto	or)					
sistar	Ambient temperature	0 to	+45 °C +32 to +	113 °F (No dew	conden	sation or	icing all	lowed), S	Storage:	–20 to -	+70 °C −	4 to +15	8 °F	
i i i i	Ambient humidity			35 1	o 85 %	RH, Sto	rage: 35	to 85 %	RH					
ment	Ambient illuminance		Inc	candescent light	3,000 {	x or less	at the l	ight-rece	eiving fac	ce (Note	9)			
Environmental resistance	Vibration resistance	10 to 55 H	łz (period: 1 mir	n.) frequency, 1.	5 mm 0.0	059 in do	ouble an	nplitude	in X,Y a	nd Z dire	ections f	or two h	ours eac	:h
E	Shock resistance	/s² acceleration	(20 G ap	prox.) ir	ı X,Y an	d Z dired	ctions th	ree time	s each					
Cabl	е			Cabtyre	cable, 0	.5 m 1.6	40 ft Ion	g with c	onnecto	r				
Cabl	e extension		E	extension up to to	otal 30 n	า 98.425	ft is pos	ssible, w	ith optio	nal cable	э.			
Mate	rial		Enclosur	e: Die-cast alum	inum, C	ase cov	er: Die-c	ast alum	ninum, F	ront cov	er: Glas	S		
Weig	ht		250 g approx. (	including cable)					300 g a	pprox. (	including	cable)		
Acce	ssory		La	aser warning lab	els (for a	pplicabl	e standa	ards and	regulati	ons): 1 s	set			

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24 V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic [aluminum vapor deposition surface reflection mirror for HL-C201A(E)-MK / HL-C201A(E)-SP2M / HL-C201F(E)-MK, clear glass for HL-C201A(E)-SP3M], and digital measurement value.

- 2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation. (Cannot be used with HL-C201 ...)
- 3) Measuring range at sampling periods of 20  $\mu s$  and 10  $\mu s$  is as follows.

Model I	No.	HL-C201□-MK	HL-C201□-SP2M	HL-C201□-SP3M	HL-C20	3□-MK	HL-C20	5□-MK	HL-C208□-MK		
Setup mode		Specular reflection	Specular reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	
0	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	+0.1 to +0.8 mm +0.004 to +0.031 in	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +5.0 mm +0.020 to +0.197 in	+0.5 to +5.0 mm +0.020 to +0.197 in	0 to +20 mm 0 to +0.787 in	0 to +6.0 mm 0 to +0.236 in	
Sampling	10 µs	+0.8 to +1.0mm +0.031 to +0.039 in	+0.7 to +0.8mm +0.028 to +0.031 in	+0.8 to +1.0mm +0.031 to +0.039 in	+3.8 to +5.0mm +0.150 in to +0.197 in	+3.6 to +4.6mm +0.142 to 0.181 in	+4.7 to +5.0mm +0.185 to +0.197 in	+4.6 to +5.0mm +0.181 to +0.197 in	+18 to +20mm +0.709 to +0.787 in	Measurement not possible	

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE" (p. 20).
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 (June 24, 2007) of FDA regulations (21 CFR 1040.10 and 1040.11).
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e<sup>2</sup> (13.5 % approx.) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- 9) Variance is  $\pm 0.03~\%$  F.S. or less depending on the ambient illuminance.

### Sensor heads

Туре						Linear bear	m spot type			
일 IEC / JIS conformed type		HL-C211B(E)-MK HL-C211C(E)-MK		HL-C235BE-MK HL-C235CE-MK		HL-C235CE-WMK				
Item FDA conformed type		HL-C211	F(E)-MK	HL-C211	F5(E)-MK		_		_	TIL-C235CE-VVIVIK
CE marking directive compliance					EN	//C Directive,	RoHS Direct	ive		
Setup mode (Note 2)		Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
Mea	surement center distance	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in
Measuring range (Note 3)		±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±200 mm ±7.874 in
Resolution [Average number of samples] (Note 4, 5)		-HL-C211B-MK / HL-C211C-MK / HL-C211F-MK / HL-C211F5-MK: 0.4 μm 0.016 mil [256], 0.1 μm 0.004 mil [4,096] -HL-C211BE-MK / HL-C211CE-MK / HL-C211FE-MK / HL-C211F5E-MK: 0.4 μm 0.016 mil [256], 0.25 μm 0.010 mil [4,096]			8 µm 0.315 mil [256], 2 µm 0.079 mil [4,096]					
Linearity (Note 6)		±0.03 % F.S.					(-200 to 0 mm -7.874 to 0 in),			
Tem	prerature characteristics	0.01 % F.S./°C								
1		Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mil)								
Ligh	t source	Max. output: 1 mW Max. output: 5 mW		Max. output: 1 mW Max. output: 5		out: 5 mW	Max. output: 5 mW			
	IEC / JIS conformed type	Class 2 (I	IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (	IEC / JIS)	Class 3R	(IEC / JIS)	Class 3R (IEC / JIS)
	FDA conformed type	Class II (I Class 2 (I	FDA), IEC / JIS)	Class IIIa Class 3R	(FDA), (IEC / JIS)					Class 3R FDA (Note 7) / IEC / JIS
Beam size (Note 8)		80 × 1,700 μm 250 × 3,500 μm 3.150 × 66.929 mil approx. 9.843 × 137.795 mil app				<b>(</b> .	400 × 6,500 μm 15.748 × 255.905 mil approx.			
Rece	eiving element	Linear image sensor								
tor	Laser emission	Green LED (lights up during laser emission)								
Indicato	Measuring range	Yellow LED  (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the measuring range.)								
92	Protection	IP67 (IEC) (excluding the connector)								
Environmental resistance	Ambient temperature	0 to +45 °C +32 to +113 °F (No dew condensation or icing allowed), Storage: –20 to +70 °C					-4 to +158 °F			
<u>18</u>	Ambient humidity				35 to 8	5 % RH, Sto	rage: 35 to 85	5 % RH		
ment	Ambient illuminance			Incandes	scent light: 3,	000 {x or less	at the light-r	eceiving face	(Note 9)	
ironi	Vibration resistance	10 to 55 Hz (period: 1 min.) frequency, 1.5 mm 0.059 in double amplitude in X,Y and Z directions						s for two hours each		
Ē	Shock resistance			196 m/s² acc	celeration (20	G approx.) ir	n X,Y and Z d	lirections thre	e times each	1
Cable		Cabtyre cable, 0.5 m 1.640 ft long with connector								
Cable extension		Extension up to total 30 m 98.425 ft is possible, with optional cable.								
Material			En	closure: Die-	-cast aluminu	m, Case cov	er: Die-cast a	luminum, Fro	nt cover: Gla	ass
Weight		300 g approx. (including cable) 450 g approx. (including cable) 300 g approx. (including cable)					300 g approx. (including cable)			
Acce	essory	Laser warning labels (for applicable standards and regulations): 1 set								
Netword Magazina conditions are as follows unless otherwise propried connection with controller supply unless 24 VDC ambient temperature, 100 °C										

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24 V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic, and digital measurement value.

- 2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation.
- 3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Model No.		HL-C211□-MK		HL-C23	HL-C235CE-WMK	
Setup mode		Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
Sampling	20 µs	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	0 to +50 mm 0 to +1.969 in	0 to +42 mm 0 to +1.654 in	-70 to +200 mm -2.756 to +7.874 in
	10 µs	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	+36 to +50 mm +1.417 to +1.969 in	+36 to +42 mm +1.417 to +1.654 in	+100 to +200 mm +3.937 to +7.874 in

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE" (p. 20).
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 (June 24, 2007) of FDA regulations (21 CFR 1040.10 and 1040.11).
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e<sup>2</sup> (13.5 % approx.) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- 9) Variance is ±0.03 % F.S. or less (±0.08 % F.S. or less for **HL-C235CE-WMK**) depending on the ambient illuminance.

### Controllers

		Туре	RS-232C-compatible	Ethernet-compatible		
		NPN output type	HL-C2C(E)	HL-C21C(E)		
Item	Nodel No	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P		
CE m		tive compliance	( )	RoHS Directive		
	nectable se	<u>.</u>	·	ble units: Max. 2 units		
Supp	oly voltage		24 V DC ±10 % includ	ding ripple 0.5 V (P-P)		
Curre	ent consun	nption	500 mA approx. at 2 sensor heads connected	I, 350 mA approx. at 1 sensor head connected		
Sam	pling cycle		10 µs, 20 µs, 40 µs, 100 µs,	, 200 μs, 400 μs, 1 ms, 2 ms		
Analog output	Voltage (I	Note 2)	Voltage output scale: $-5$ to $+5$ V/F.S. (initial value) Output range during normal status: $-10.0$ to $+10.0$ V Output at abnormal status: $-10.8$ V or $+10.8$ V Resolution: 2 mV, Linearity: $\pm0.05$ % F.S. Max. 2 mA, output impedance $50$ $\Omega$ , Response delay time: $1.5$ $\mu$ s/V approx.			
	Current (I	Note 3)	Current output scale: 4 to 20 mA/F.S. (initial value) Output range during normal status: 2 to 24 mA Output at abnormal status: 1 mA or 25 mA Resolution: 3 µA, Linearity: ±0.05% F.S. Load impedance: 250 Ωmax., Response delay time: 10 µs approx.			
Alarn	n output		<npn output="" type=""> NPN open-collector transistor <ul> <li>Maximum sink current: 100 mA</li> <li>Applied voltage: 30 V DC or less</li> <li>[between alarm output and Common (–)]</li> <li>Residual voltage: 1 V or less (at 100 mA sink current)</li> </ul></npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between alarm output and +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>		
	Output op	eration	Opened when the amou	unt of light is insufficient		
	Short-circ	uit protection	Incorp	orated		
Judgment output (HI, GO, LO)		ut	<npn output="" type=""> NPN open-collector transistor <ul> <li>Maximum sink current: 100 mA</li> <li>Applied voltage: 30 V DC or less</li> <li>[between judgment output to Common (–)]</li> <li>Residual voltage: 1 V or less (at 100 mA sink current)</li> </ul></npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between judgment output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>		
	Output or	eration	Opened at output operation			
	Short-circ	uit protection	Incorporated			
Strobe output			<npn output="" type=""> NPN open-collector transistor <ul> <li>Maximum sink current: 100 mA</li> <li>Applied voltage: 30 V DC or less</li> <li>[between strobe output to Common (-)]</li> <li>Residual voltage: 1 V or less (at 100 mA sink current)</li> </ul></npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between strobe output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>		
	Output op	eration	,	a determination		
	Short-circ	uit protection	Incorp	porated		
Remote interlock input		k input	<ul> <li>NPN output type&gt;     Laser emission is delayed when connected to Common (–).     Laser emission stop at open     Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)     </li> </ul>	<pnp output="" type=""> Laser emission is delayed when connected to IL (+). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>		
Laser control input		put	<npn output="" type=""> Laser emission is stopped when connected to Common (–). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is stopped when connected to external power (+) Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>		
Zero set input			<npn output="" type=""> Zero set is ON when connected with Common (–). Zero set turns to OFF after continuously connected to Common (–) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Zero set is ON when connected with external power (+). Zero set turns to OFF after continuously connected to external power (+) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>		
Timing input			<npn output="" type=""> ON at/during connection to Common (–) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> ON at/during connection to external power (+) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>		
Reset input			<npn output="" type=""> Reset is done when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>			
Memory change input			<npn output="" type=""> Memory is specified when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Memory is specified when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>		
RS-2	232C interfa	ace	Baud rate 9,600, 19,200, 38,400, 115,200 bit/s	<del></del>		
Ethernet interface (Note 4)		ce (Note 4)		IEEE802.3u, 10BASE-T/100BASE-TX RJ45 Compatible protocols: iQSS-compatible proprietary protocol, MC protocol, MEWTOCOL		
USB	interface		USB 2.0 full speed (USB 1.1 compatible) compliant			
Setting / Data Display		Display	GT12 Programmable Display (optional)			

### **Controllers**

		Туре	RS-232C-compatible	Ethernet-compatible	
	Š	NPN output type	HL-C2C(E)	HL-C21C(E)	
Iter	Model No.	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P	
	Power		Green LED (light	s up at power on)	
ō	Sensor head A Laser radiation		Green LED (lights up during or immediately before laser emission of sensor head A)		
Indicator	Sensor head B Laser radiation		Green LED (lights up during or immediately before laser emission of sensor head B)		
	Alarm 1		Red LED (lights up when OUT1 can not be measured due to insufficient amount of light)		
	Alarm 2		Red LED (lights up when OUT2 can not be measured due to insufficient amount of light)		
ance	Ambient temperature		0 to +50 °C +32 to +122 °F (No dew condensation or icing allowed), Storage: –20 to +70 °C –4 to +158 °F		
Environmental resistance	Ambient h	umidity	35 to 8	5 %RH	
nment	Vibration r	resistance	10 to 55 Hz frequency (period: 1 min.), 0.75 mm 0.030 in double amplitude in X, Y and Z directions for 30 min. each		
Envir	Shock res	istance	196 m/s $^2$ acceleration (20 G approx.) in X, Y, and Z directions three times each		
Material			Case: Polycarbonate, Connector cap: PE Case: Polycarbonate		
Weight			450 g approx.		
Accessories			USB cable (2 m 6.562 ft long): 1 pc., Short bracket: 1 pc.  USB cable (2 m 6.562 ft long): 1 pc., Short bracket: 1 pc.  Ferrite core (E04SR200935A made by Seiwa Electric Mft		

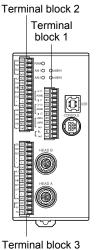
Notes: 1) **HL-C2C(-P)** / **HL-C21C(-P)** are restricted for export in accordance with the "Foreign Exchange and Foreign Trade Law". These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE" (p.20).

- 2) The linearity is F.S.=20 V to digital measurement value. Response delay time is the period after update of measurement value.
- 3) The linearity is F.S.=16 mA to digital measurement value. Response delay time is the period after update of measurement value.
- 4) For Ethernet communication settings of **HL-C21C(E)** (-**P**), **Configurator WD** (Ethernet communication setting tool, Ver. 1.62 or later) is required. Please download it from our website for use.

Terminal block 2

### I/O CIRCUIT AND WIRING DIAGRAMS

### **Terminal arrangement**



Terminal block 1				
Terminal	Function			
NPN PNP				
(V)1	Analog voltage output (for OUT1)			
AGND	Analog ground			
(I)1	Analog current output (for OUT1)			
(V)2	Analog voltage output (for OUT2)			
AGND	Analog ground			
(I)2	Analog current output (for OUT2)			
LSRA	Laser control input (for Head A) Laser stop during short circuit			
LSRB	Laser control input (for Head B) Laser stop during short circuit			
(-)	Common (–)			
IL IL-	Remote interlock Laser stop when opened.			
(–) IL+	Remote interlock common			

Function	
Timing input (for OUT2) ON during short circuit	
Reset input (for OUT2) ON during short circuit	
Common (–)	
Alarm output (for OUT2)	
Strobe output (for OUT2)	
Judgment HI output (for OUT2)	
Judgment GO output (for OUT2)	
Judgment LO output (for OUT2)	
Reserved terminal (Note 2)	
Common (–) / Common (+)	
Mamany shangs (16 ways)	
Memory change (16 ways)	

Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

Common (-)

МЗ

2) Do not connect anything to the reserved terminals.

Terminal	DIOCK 3

Terminal	Function	
NPN PNP	i unction	
ZS1	Zero set input (for OUT1) ON during short circuit (Note 1)	
TM1	Timing input (for OUT1) ON during short circuit	
RS1	Reset input (for OUT1) ON during short circuit	
•	Reserved terminal (Note 2)	
•	Reserved terminal (Note 2)	
(-)	Common (–)	
AL1	Alarm output (for OUT1)	
ST1	Strobe output (for OUT1)	
HI1	Judgment HI output (for OUT1)	
GO1	Judgment GO output (for OUT1)	
LO1	Judgment LO output (for OUT1)	
•	Reserved terminal (Note 2)	
(-) (+)	Common (–) / Common (+)	
24 V	24 V DC input for power supply	
0 V	Power supply ground 0 V	
FG	Frame ground	

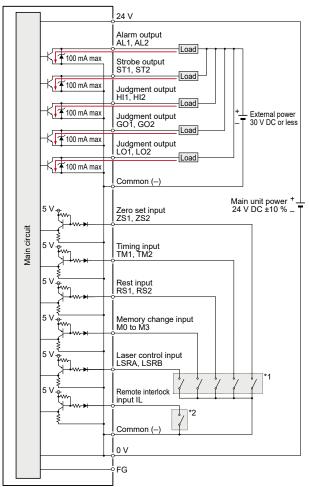
Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

2) Do not connect anything to the reserved terminals.

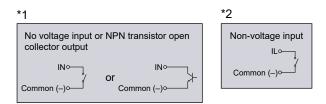
### I/O CIRCUIT AND WIRING DIAGRAMS

### **NPN** output type

### I/O circuit diagrams

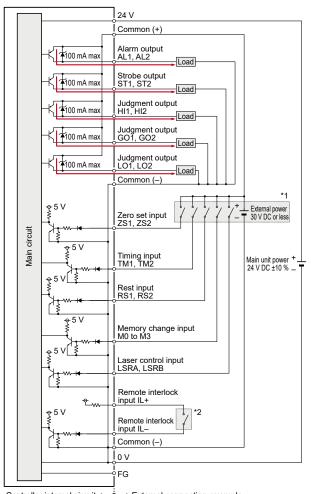


Controller internal circuit <del>← o External connection example</del>

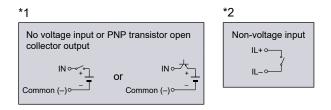


### PNP output type

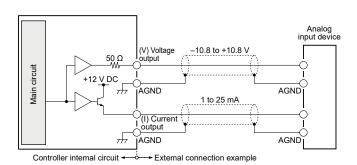
### I/O circuit diagrams



Controller internal circuit + ➤ External connection example



### Analog output (Common in NPN output type and PNP output type)



Notes: 1) Do not short-circuit analog output terminals or apply voltage to them.

2) Use shielded wires for analog outputs.

### SENSING CHARACTERISTICS (TYPICAL)

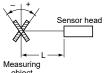
### HL-C201A HL-C201F

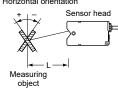
### Correlation between measuring distance and error characteristics

### Setup mode: Specular reflection

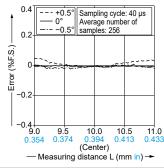
Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation

Aluminum vapor deposition surface reflection mirror (0°, ±0.2°) Horizontal orientation Sensor head

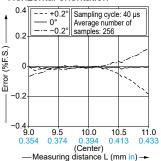




### Vertical orientation



### · Horizontal orientation



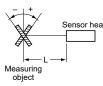
### HL-C201A-SP2

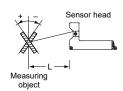
### Correlation between measuring distance and error characteristics

### Setup mode: Specular reflection

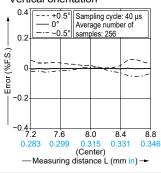
Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation

Aluminum vapor deposition surface reflection mirror (0°, ±0.2°) Horizontal orientation

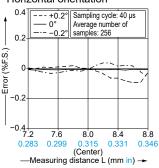




### Vertical orientation



### · Horizontal orientation

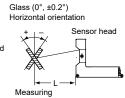


### HL-C201A-SP3

### Correlation between measuring distance and error characteristics

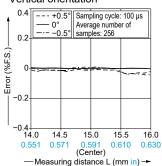
### Setup mode: Specular reflection

Glass (0°, ±0.5°) Vertical orientation Sensor head Measuring

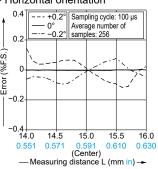


obiect

### Vertical orientation



### · Horizontal orientation



### HL-C203B HL-C203F

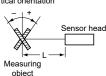
object

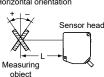
### Correlation between measuring distance and error characteristics

### Setup mode: Diffuse reflection

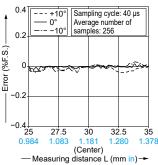
White ceramic (0°, ±10°) Vertical orientation

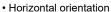
White ceramic (0°, ±10°) Horizontal orientation

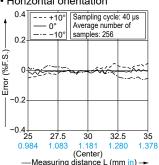




### Vertical orientation



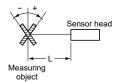


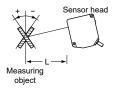


### Setup mode: Specular reflection

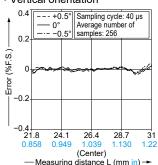
Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation

Aluminum vapor deposition surface reflection mirror (0° +0.2°) Horizontal orientation

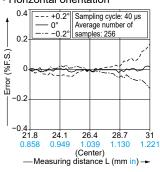




### Vertical orientation



· Horizontal orientation

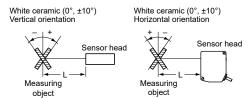


### SENSING CHARACTERISTICS (TYPICAL)

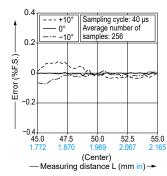
### HL-C205B HL-C205C

# Correlation between measuring distance and error characteristics

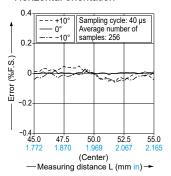
### Setup mode: Diffuse reflection



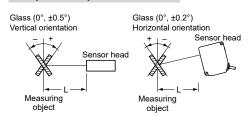
### Vertical orientation



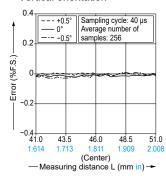
### · Horizontal orientation



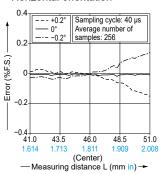
# Setup mode: Specular reflection



Vertical orientation



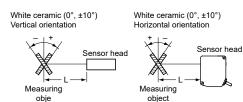
· Horizontal orientation



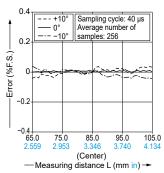
### HL-C208B HL-C208C

# Correlation between measuring distance and error characteristics

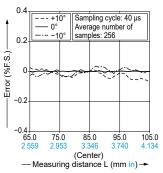
### Setup mode: Diffuse reflection



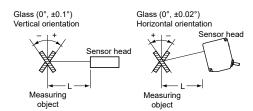
### Vertical orientation



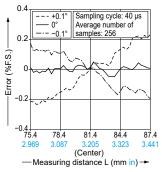
### · Horizontal orientation



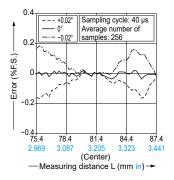
### Setup mode: Specular reflection



### Vertical orientation



### Horizontal orientation

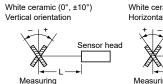


### SENSING CHARACTERISTICS (TYPICAL)

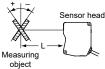
### HL-C211B HL-C211C HL-C211F HL-C211F5

# Correlation between measuring distance and error characteristics

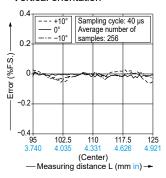
### Setup mode: Diffuse reflection



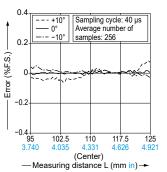
White ceramic (0°, ±10°) Horizontal orientation



### · Vertical orientation



### · Horizontal orientation

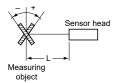


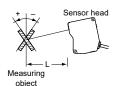
### Setup mode: Specular reflection

Aluminum vapor deposition surface reflection mirror (0°, ±0.1°) Vertical orientation

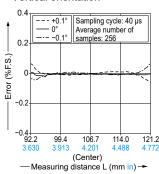
object

Aluminum vapor deposition surface reflection mirror (0°, ±0.05°) Horizontal orientation

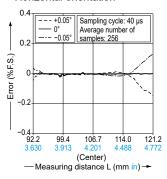




### Vertical orientation



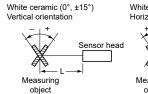
### · Horizontal orientation



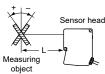
### HL-C235BE HL-C235CE

# Correlation between measuring distance and error characteristics

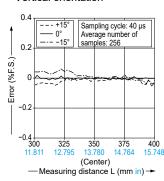
### Setup mode: Diffuse reflection



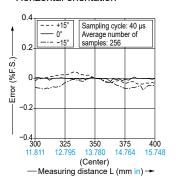
White ceramic (0°, ±15°) Horizontal orientation



### Vertical orientation



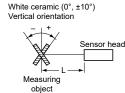
### Horizontal orientation



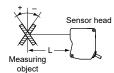
### HL-C235CE-W

# Correlation between measuring distance and error characteristics

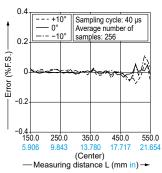
### Setup mode: Diffuse reflection



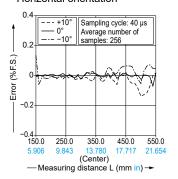
White ceramic (0°, ±10°) Horizontal orientation



### Vertical orientation



### Horizontal orientation



Refer to the instruction manual for details. The instruction manual can be download from our website.

This catalog is a guide to select a suitable product.
 Be sure to read instruction manual attached to the product prior to its use.

 Never use this product as a sensing device for personnel protection.



- In case of using sensing devices for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.
- Do not use in environments with flammable gases. Usage may cause an explosion.

 Do not operate products using methods other than those described in the instruction manual included with each product. Control or adjustment through procedures other than those specified may cause hazardous laser radiation exposure.



- The following labels are attached to the products. Handle each product according to the instruction given on the warning label.
- Types which comply with FDA regulations have an English label applied based on those FDA regulations.

### HL-C201A(E)(-MK) / HL-C201A(E)-SP2(M) / HL-C201A(E)-SP3(M)

 This product is classified as a Class 1 Laser Product in IEC / JIS standards. Do not look at the laser beam through optical devices such as a lens.



HL-C203B(E)(-MK) / HL-C205B(E)(-MK) / HL-C208B(E)(-MK) / HL-C211B(E)(-MK) / HL-C235BE(-MK)

 This product is classified as a Class 2 Laser Product in IEC / JIS standards. Do not look at the laser beam directly or through optical devices such as a lens.



HL-C205C(E)(-MK) / HL-C208C(E)(-MK) / HL-C211C(E)(-MK) / HL-C235CE(-MK) / HL-C235CE-W(-MK)

 This product is classified as a Class 3R Laser Product in IEC / JIS standards. Never directly look at or touch the laser beam or its reflection.



 Do not use outside of specification ranges for ratings, environmental conditions, etc. Abnormal heat or smoke generation may occur.



- Do not disassemble or modify these products. Electrical shock or smoke generation may occur.
- Connect electrical wires securely with terminal screws. Imperfect connections may cause abnormal heat or smoke generation.
- Do not touch the terminal while power is being supplied to the product. Electrical shock may occur.

 Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control, which is defined by "Foreign Exchange and Foreign Trade Act"

Therefore, anyone who wishes to export or transfer these products outside of Japan is required to obtain the necessary license from the Ministry of Economy, Trade and Industry of Japan.

Also, these products fall under international export control regulations, such as Nuclear Suppliers Group (NSG) guidelines 1.B.3.b.1 and Wassenaar Arrangement (WA) 2.B.6.b.1.a, and are objects of the regulation. Please comply with the export control in each country.

Note: These products are introduced to limited countries only. Please contact our office for details.

### Warming up time

 To ensure the performance of the product, before use allow at least 30 minutes of warming up after turning on the power.

### Safety standards for laser beam products

 A laser beam can harm human being's eyes, skin, etc., because of its high energy density. IEC and JIS have classified laser products according to the degree of hazard and the stipulated safety requirements.

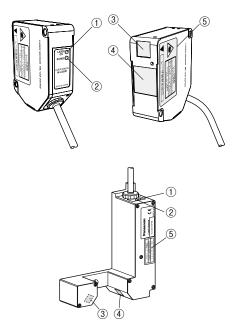
### Safe use of laser products

 For the purpose of preventing users from suffering injuries by laser products, IEC 60825-1(Safety of laser products). Please check the standards before use.

Refer to the instruction manual for details. The instruction manual can be download from our website.

### **Fuctional description**

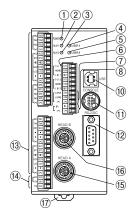
### Sensor head



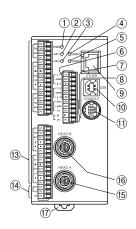
	Description	Function
1	Laser emission indicator (Green LED)	Lights up during laser emission.
2	Measurement range indicator (Yellow LED)	Lights up when the target reaches the approximate center of the measurement. Blinks when the target enters within the measurement range. Turns off the light when the target goes out of the measurement range.
3	Light emitter	Emits the laser light.
4	Light receiver	Receives the laser specular light from a measurement target.
(5)	Warning label	Shows the laser emission position. Please read carefully before use.

### Controller

# <RS-232C-compatible> HL-C2C□



# <Ethernet-compatible> HL-C21C□

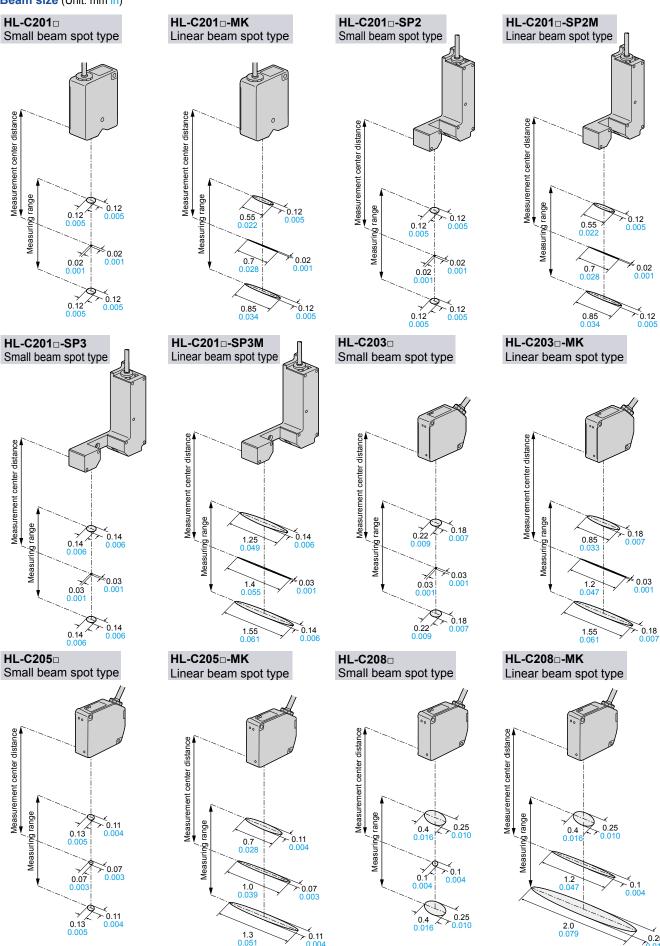


	Description	Function				
1	POWER indicator	Lights up in green when electricity is provided to the controller.				
2	ALM1 (Alarm) indicator	Abnormal condition indicator for OUT1. Lights up in red during dark status (poor light intensity) of OUT1 or the sensor head is in unconnected status.				
3	ALM2 (Alarm) indicator	Abnormal condition indicator for OUT2. Lights up in red during dark status (poor light intensity) of OUT2 or the sensor head is in unconnected status.				
4	LASER A indicator	Lights up in green during the laser radiation of Head A.				
(5)	LASER B indicator	Lights up in green during the laser radiation of Head B.				
6	Analog output terminal	Terminal for analog data output.				
7	Laser control terminal	Stops laser emission in case of short-circuiting.				
8	Remote interlock terminal	Stops laser emission when it's opened.				
9	Ethernet connector	Equipped on <b>HL-C21C</b> models. Used for Ethernet communication with controllers.				
10	USB connector	Used for communication with PC using USB.				
11)	Console connection connector	Used for connecting the console.				
12	RS-232C connector	Equipped on <b>HL-C2C</b> models. Used for RS-232C communication with controllers.				
13	I/O terminal	Terminal for various I/O and memory change.				
14)	Power terminal	Terminal for power supply to the controller.				
15)	Sensor head A connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head A" and starts operation.				
16	Sensor head B connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head B" and starts operation.				
17	DIN rail mounting hook	Used for hooking / removing the sensor heads to / from the 35 mm 1.378 in width DIN rail with one-touch simple operation.				
Note	ote: In case of connecting one sensor head to the controller, be sure					

Note: In case of connecting one sensor head to the controller, be sure to connect the sensor head to (§) the sensor head A connection connector (HEAD A) side. If the sensor head is connected to (§) the sensor head B connection connector (HEAD B) side, the measurement cannot be performed.

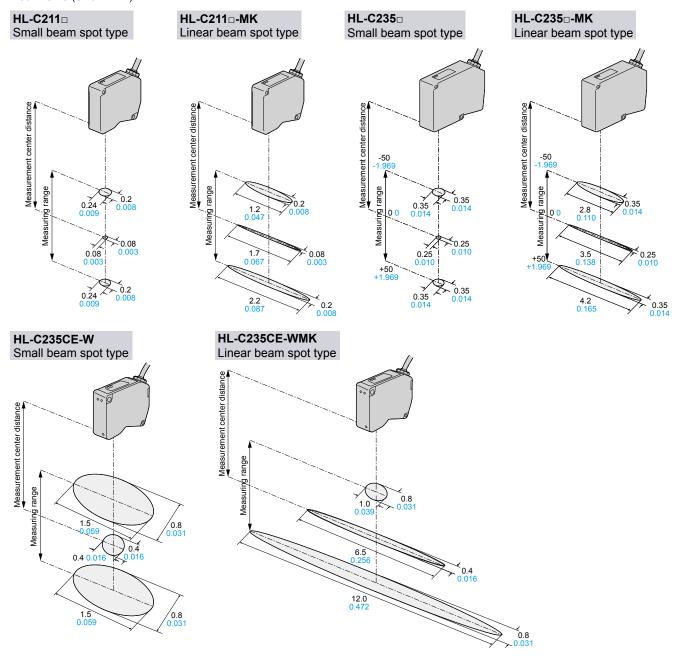
Refer to the instruction manual for details. The instruction manual can be download from our website.





Refer to the instruction manual for details. The instruction manual can be download from our website.

### Beam size (Unit: mm in)



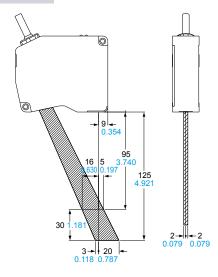
Refer to the instruction manual for details. The instruction manual can be download from our website.

### Mutual interference (Unit: mm in)

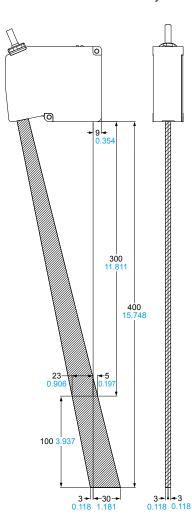
 When installing two or more sensor heads side by side, mutual interference will not occur if the laser spots from other sensor heads do not fall within the shaded areas in the figure below. When connecting two sensor heads to one controller, the mutual interference prevention function can be used. Therefore the measures shown below are not necessary in that case.

# HL-C203<sub>□</sub>

### HL-C211<sub>□</sub>

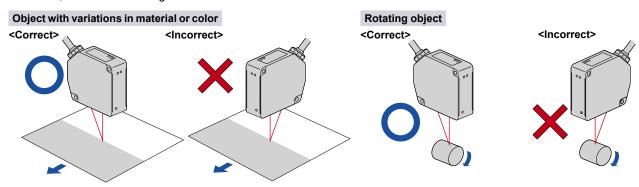


### HL-C235□

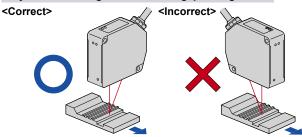


### Sensor head mounting direction

 To obtain the greatest precision, the sensor head should be oriented facing the direction of movement of the object's surface, as shown in the figure below.



### Object that has large differences in gaps and grooves



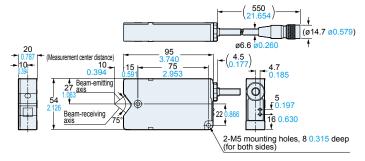
### DIMENSIONS (Unit: mm in)

The CAD data can be downloaded from our website.

### HL-C201 HL-C201 -MK

Sensor head

### Setup mode: Specular reflection type



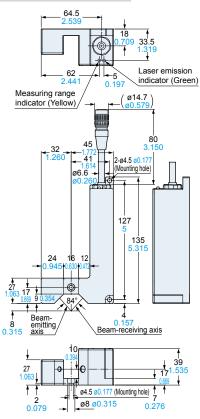
### HL-C201 -- SP2 HL-C201 -- SP2M

Sensor head

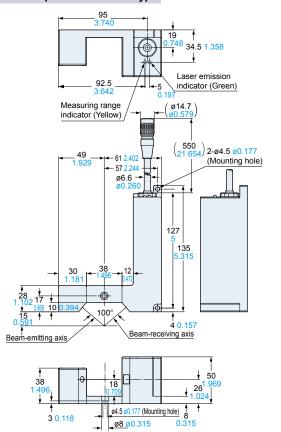
### HL-C201 -- SP3 HL-C201 -- SP3M

Sensor head

### Setup mode: Specular reflection type



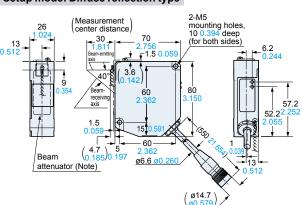
### Setup mode: Specular reflection type



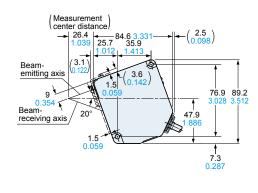
### HL-C203 HL-C203-MK

Sensor head

### Setup mode: Diffuse reflection type



### Setup mode: Specular reflection type



Note: A beam attenuator is not available for JIS / IEC conformed types.

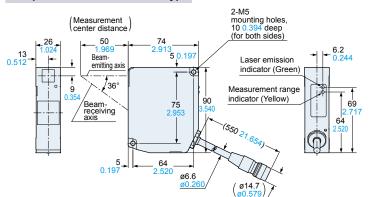
### DIMENSIONS (Unit: mm in)

The CAD data can be downloaded from our website.

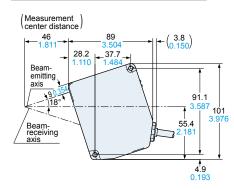
### HL-C205□ HL-C205□-MK

Sensor head

### Setup mode: Diffuse reflection type



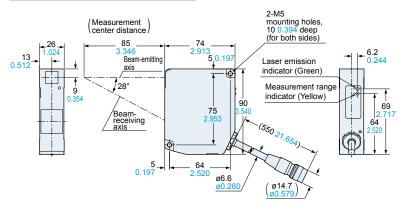
### Setup mode: Specular reflection type



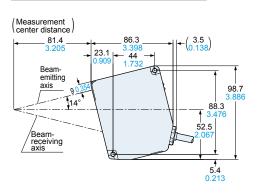
### HL-C208□ HL-C208□-MK

Sensor head

### Setup mode: Diffuse reflection type



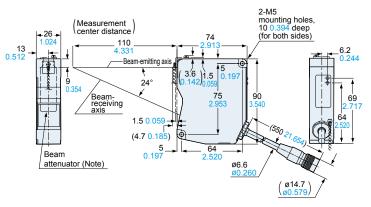
### Setup mode: Specular reflection type



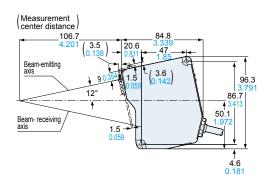
### HL-C211 HL-C211 -- MK

Sensor head

### Setup mode: Diffuse reflection type



### Setup mode: Specular reflection type



Note: A beam attenuator is not available for IEC/JIS conformed types.

### DIMENSIONS (Unit: mm in)

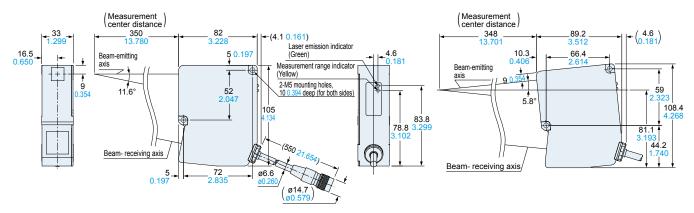
The CAD data can be downloaded from our website.

### HL-C235□ HL-C235□-MK

Sensor head

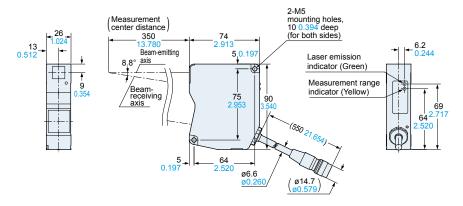
### Setup mode: Diffuse reflection type

### Setup mode: Specular reflection type

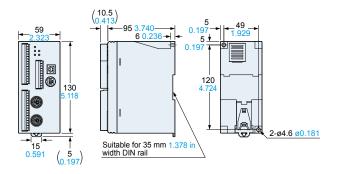


### HL-C235CE-W HL-C235CE-WMK

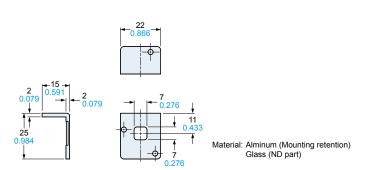
Sensor head



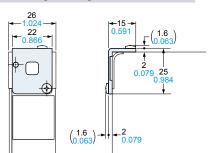
### HL-C2C□ HL-C21C□ Controller



HL-C2F01 ND filter (Optional)



### Mounting drawing with a sensor head



- Notes: 1) **HL-C201**□ cannot be mounted.
  - 2) For **HL-C235**: (-MK) models, mounting is on 2 places on the front panel.
  - 3) Cannot be attached to FDA conformed types when a beam attenuator is in use.

### Disclaimer

The applications described in the catalog are all intended for examples only. The purchase of our products described in the catalog shall not be regarded as granting of a license to use our products in the described applications. We do NOT warrant that we have obtained some intellectual properties, such as patent rights, with respect to such applications, or that the described applications may not infringe any intellectual property rights, such as patent rights, of a third party.



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